

Product Summary

| | | |
|-----------------------------|-----------------------------|----------------------------|
| V_{BR} (min) | I_{PP} (max) | I_R (max) |
| 28V | 9.5A | 100nA |

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripheral

Features

- Low Profile Package (0.605mm max) and Ultra-small PCB Footprint Area (2.05 * 2.05mm max) Suitable for Compact Portable Electronics
- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV, Contact ±30kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

- Case: U-DFN2020-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208 ^(e4)
- Weight: 0.0065 grams (approximate)



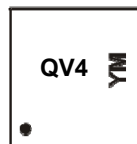
Device Schematic

Ordering Information (Note 4)

| Product | Compliance | Marking | Reel Size (inches) | Tape Width (mm) | Quantity per Reel |
|-----------------|------------|---------|--------------------|-----------------|-------------------|
| D26V0H1U2LP20-7 | Standard | QV4 | 7 | 8 | 3,000/Tape & Reel |

- Notes:
- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 - See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



QV4 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: B = 2014)
 M = Month (ex: 9 = September)

Date Code Key

| Year | 2013 | 2014 | 2015 | 2016 | 2017 | 2018 | 2019 |
|------|------|------|------|------|------|------|------|
| Code | A | B | C | D | E | F | G |

| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | O | N | D |

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | Conditions |
|------------------------------------|--------------------------|-------|------|-------------------------|
| Peak Pulse Power Dissipation | P _{PP} | 300 | W | 10/1000μs, Per Figure 1 |
| Peak Pulse Current | I _{PP} | 9.5 | A | 10/1000μs, Per Figure 1 |
| ESD Protection – Contact Discharge | V _{ESD_Contact} | ±30 | kV | IEC 61000-4-2 Standard |
| ESD Protection – Air Discharge | V _{ESD_Air} | ±30 | kV | IEC 61000-4-2 Standard |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Package Power Dissipation (Note 5) | P _D | 500 | mW |
| Thermal Resistance, Junction to Ambient (Note 5) | R _{θJA} | 250 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to +150 | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Conditions |
|----------------------------------|------------------|-----|-----|------|------|--|
| Reverse Standoff Voltage | V _{RWM} | — | — | 26 | V | — |
| Channel Leakage Current (Note 6) | I _{RM} | — | — | 100 | nA | V _{RWM} = 26V |
| Forward Voltage | V _F | 0.6 | 0.8 | 1.2 | V | I _R = 10mA |
| Clamping Voltage | V _{CL} | — | — | 40 | V | I _{PP} = 9.5A, t _p = 10/1000μs |
| Breakdown Voltage | V _{BR} | 28 | — | 31.9 | V | I _R = 1mA |
| Channel Input Capacitance | C _T | — | 630 | — | pF | V _R = 0V, f = 1MHz |

- Notes:
- Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at <http://www.diodes.com>.
 - Short duration pulse test used to minimize self-heating effect.

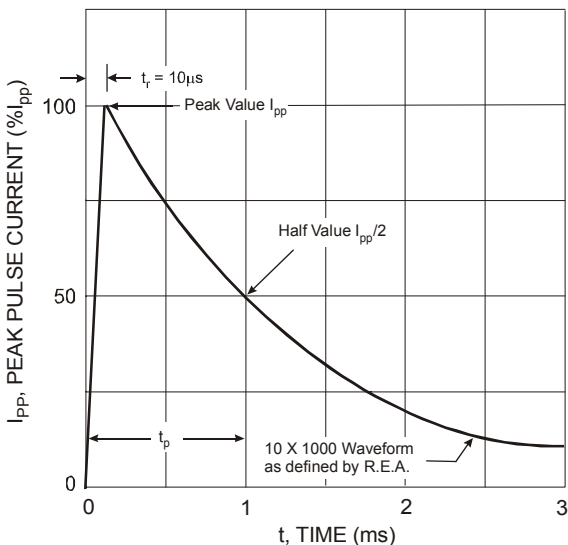


Figure 1 Pulse Waveform

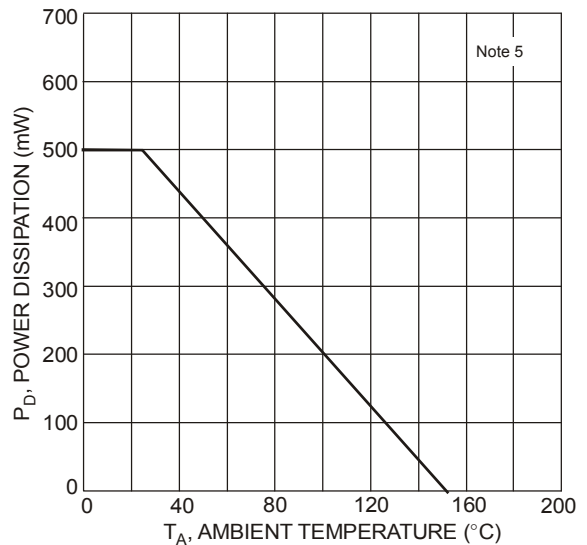


Figure 2 Power Derating Curve

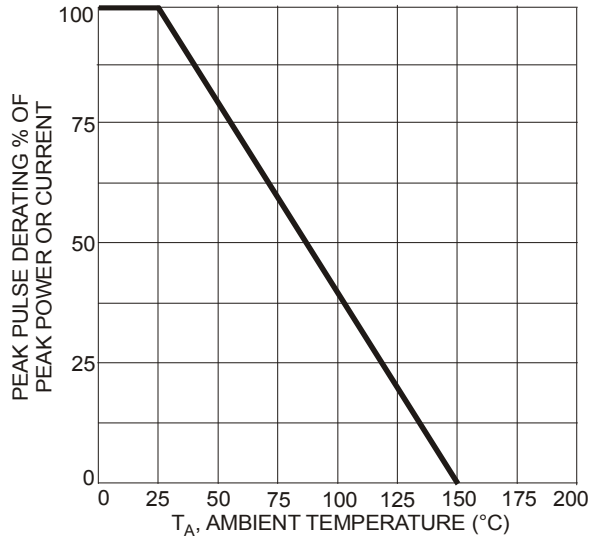


Figure 3 Power Dissipation vs. Ambient Temperature

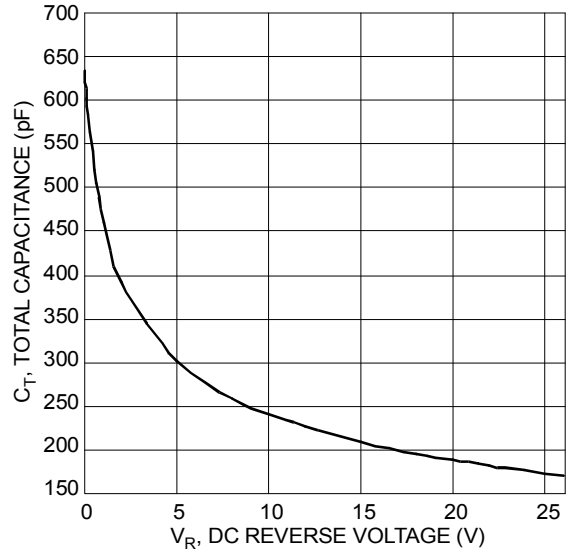


Figure 4 Typical Total Capacitance

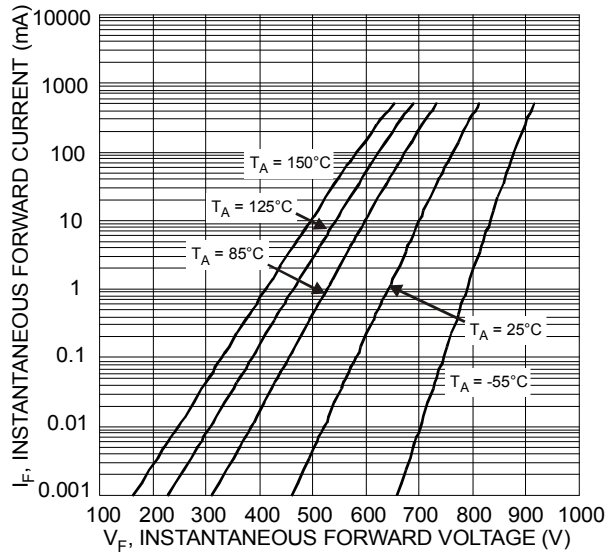


Figure 5 Typical Forward Characteristics

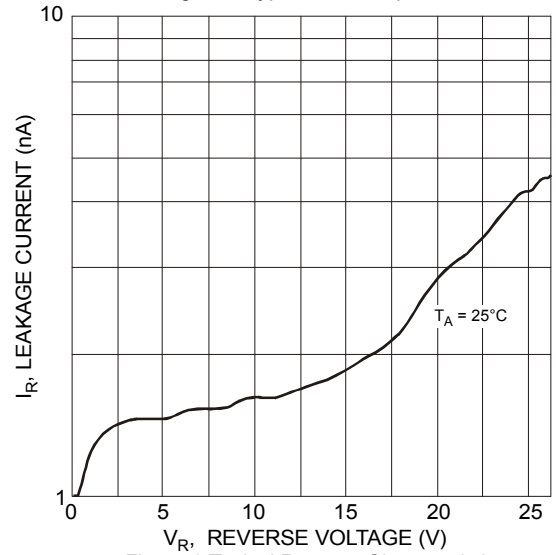
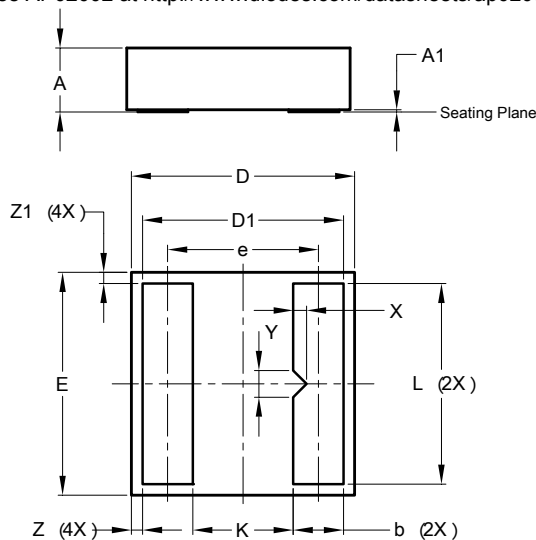


Figure 6 Typical Reverse Characteristics

Package Outline Dimensions

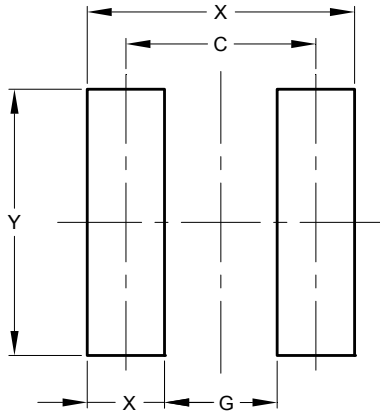
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



| U-DFN2020-2 | | | |
|----------------------|----------|-------|-------|
| Dim | Min | Max | Typ |
| A | 0.545 | 0.605 | 0.575 |
| A1 | 0 | 0.05 | 0.02 |
| b | 0.35 | 0.55 | 0.45 |
| D | 1.90 | 2.10 | 2.00 |
| D1 | 1.70 | 1.90 | 1.80 |
| E | 1.90 | 2.10 | 2.00 |
| e | 1.35 BSC | | |
| K | 0.80 | 1.00 | 0.90 |
| L | 1.70 | 1.90 | 1.80 |
| X | - | - | 0.120 |
| Y | - | - | 0.240 |
| Z | 0.10 BSC | | |
| Z1 | 0.10 BSC | | |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 1.350 |
| G | 0.800 |
| X | 0.550 |
| X1 | 1.900 |
| Y | 1.900 |

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